

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	METHOD OF FORMING STRAINED SILICON MATERIALS WITH IMPROVED THERMAL CONDUCTIVITY	
<p>Application Number : </p> <p>Date : </p> <p>First Named Applicant: Stephen W. Bedell</p> <p>Confirmation Number: </p> <p>Attorney Docket Number: FIS920040069</p>		
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Documents being submitted:	Files
us-assignment	FIS920040069-usassn.xml us-assignment.xsl us-assignment.dtd FIS920040069assign1.tif FIS920040069assign2.tif FIS920040069assign3.tif FIS920040069assign4.tif
us-request	FIS920040069-usrequ.xml us-request.dtd us-request.xsl
us-fee-sheet	FIS920040069-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
us-ids	FIS920040069-usidst.xml us-ids.dtd us-ids.xsl
application-body	FIS920040069-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogrk3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblk.dtd FIS920040069dwg1.tif FIS920040069dwg2.tif
us-declaration	FIS920040069dec1.tif
us-declaration	FIS920040069dec2.tif
us-declaration	FIS920040069dec3.tif

us-declaration	FIS920040069dec4.tif
us-declaration	FIS920040069dec5.tif
us-declaration	FIS920040069dec6.tif
Comments	
Assignee Name: International Business Machines Corporation, Assignee Residence: Armonk, NY 10504	